

# Siyuan Cheng

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## EDUCATION

### Columbia University

**Master of Science, Mechanical Engineering**, [GPA: 3.47/4.00]

Courses: Advanced Manufacturing Processes, Advanced Mechanics of Fluids, MEMS Systems, MEMS Production and Packaging

New York, United States

Aug 2021 - Feb 2023

### University of Shanghai for Science and Technology

**Bachelor of Engineering, Energy and Power Engineering**, [Major GPA: 3.77/4.00]

Courses: Mechanics of Material, Mechanical Design, Thermodynamic, Measuring and Control Technology

Honors: First-class scholarship (2019, 2020, 2021), outstanding graduate (2021)

Shanghai, China

Sep 2017 - Jun 2021

## WORK EXPERIENCE

### Huawei Technologies Co., Ltd - Mechanical Engineer

*4D Automotive Radar System Design*

Shanghai, China

Apr 2023 - Present

- Led the structural development of next-generation mass-production radar, including component and assembly design, 3D modeling, creation of engineering drawings, and tolerance analysis to ensure manufacturability.
- Optimized product EMC protection, heat dissipation, stacking, and material selection through structural design, leading to a patented solution that reduced component manufacturing costs by 75% compared to the previous generation.
- Developed simulation plans based on automotive industry standards and conducted static and dynamic structural analyses using Abaqus to evaluate and optimize product performance.
- Conducted supply chain MFG reviews and DOE experiments to identify potential failures. Improved product yield from 80% to 90+%.

### *Plastic Laser Transmission Welding (LTW) Process Research*

- Designed and produced small-batch prototypes using 3D printing and simple molds for LTW process research, independently set up experimental environments to conduct mechanical tests on structural designs and plastic materials.
- Developed a 3D FEA contact model for laser transmission welding based on volumetric heat sources using ANSYS and conducted simulations and experimental studies on different interface contact conditions.
- Analyzed simulation and DOE experimental data. Used Minitab to determine optimal plastic injection molding and laser welding parameters, resulting in a 42% improvement in bond strength.

### *Optical system design*

- Designed metal components for coupling optical lenses and laser emitters, reducing thermal backflow through structural optimization and minimizing thermal deformation impact on optical accuracy using powder metallurgy technology (MIMS).
- Conducted metallographic and EDS analysis on failed components to investigate the corrosion failure mechanism of MIMS coatings, developing improved electroplating techniques that enhanced corrosion resistance by 50%.
- Took charge of designing optical lenses for LiDAR, implemented glass toughening, machining, and PVD coating process improvements, and led multiple failure analyses of optical lenses.

## ACADEMIC PROJECTS

### Research on Fluid Mechanics of Micropumps

*Research Assistant*

New York, United States

Jan 2022 - Jun 2022

- Designed and modeled a compact piezoelectric micropump with dimensions of 25mm x 25mm x 5mm using SolidWorks.
- Conducted multi-condition coupled simulations using COMSOL to study the micropump's operating principles and fluid flow dynamics.
- Analyzed data to identify key factors of micropump and proposed practical methods to improve flow rate, finished a research paper.

### MEMS Scanning Mirror Design

*Course Research*

New York, United States

Sep 2021 - Dec 2021

- Led a team to design a piezoelectric MEMS scanning mirror with a wider scanning angle, enabling more flexible beam control.
- Created a 3D model of the scanning mirror, performed structural simulations using ANSYS, and designed a feasible etching process.
- Optimized the MEMS scanning mirror design based on simulation results, achieving a scanning angle of up to 25°.

### Analysis and Design of Microchannel Heat Sink

*Graduation project*

Shanghai, China

Dec 2020 - Jun 2021

- Designed a novel microchannel heat sink structure with a bionic fish-scale pattern to attain a heat dissipation efficiency of 100 W/cm<sup>2</sup>.
- Conducted thermal simulations using ANSYS Fluent to study heat transfer and fluid flow mechanisms of single-phase water in microchannels, optimizing the structure to balance heat dissipation efficiency and pressure loss, outperforming traditional designs.

## PUBLICATIONS

- Mechanism research on radiation in the phase transition of water. *Energy Research and Information*, 2021, 37(1): 40-45.

## SKILLS

- Computer Aided Engineering: SolidWorks | PRO/E | AutoCAD | ANSA | Abaqus | ANSYS | COMSOL | Python 3.0 | MATLAB